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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	11024
Number of Logic Elements/Cells	99216
Total RAM Bits	8183808
Number of I/O	1040
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-FCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp100-5ffg1704c

Virtex-II Pro / Virtex-II Pro X Device/Package Combinations and Maximum I/Os

Offerings include ball grid array (BGA) packages with 1.0 mm pitch. In addition to traditional wire-bond interconnect (FG/FGG packages), flip-chip interconnect (FF packages) is used in some of the BGA offerings. Flip-chip interconnect construction supports more I/Os than are possible in wire-bond versions of similar packages, providing a high pin count and excellent power dissipation.

The device/package combination table (Table 3) details the maximum number of user I/Os and RocketIO / RocketIO X MGTs for each device and package using wire-bond or flip-chip technology.

The FF1148 and FF1696 packages have no RocketIO transceivers bonded out. Extra SelectIO-Ultra resources occupy available pins in these packages, resulting in a higher user I/O count. These packages are available for the XC2VP40, XC2VP50, and XC2VP100 devices only.

The I/Os per package count includes all user I/Os except the 15 control pins (CCLK, DONE, M0, M1, M2, PROG_B, PWRDWN_B, TCK, TDI, TDO, TMS, HSWAP_EN, DXN, DXP, and RSVD), VBATT, and the RocketIO / RocketIO X transceiver pins.

Table 3: **Virtex-II Pro Device/Package Combinations and Maximum Number of Available I/Os**

Package(1)	FG256/ FGG256	FG456/ FGG456	FG676	FF672	FF896	FF1152	FF1148	FF1517	FF1704	FF1696
Pitch (mm)	**1.00**	**1.00**	**1.00**	**1.00**	**1.00**	**1.00**	**1.00**	**1.00**	**1.00**	**1.00**
Size (mm)	**17 x 17**	**23 x 23**	**26 x 26**	**27 x 27**	**31 x 31**	**35 x 35**	**35 x 35**	**40 x 40**	**42.5 x 42.5**	**42.5 x 42.5**
XC2VP2	140 / 4	156 / 4		204 / 4						
XC2VP4	140 / 4	248 / 4		348 / 4						
XC2VP7		248 / 8		396 / 8	396 / 8					
XC2VP20			404 / 8		556 / 8	564 / 8				
XC2VPX20					552 / 8(2)					
XC2VP30			416 / 8		556 / 8	644 / 8				
XC2VP40			416 / 8			692 / 12	804 / 0(3)			
XC2VP50						692 / 16	812 / 0(3)	852 / 16		
XC2VP70								964 / 16	996 / 20	
XC2VPX70									992 / 20(2)	
XC2VP100									1,040 / 20	1,164 / 0(3)

Notes:
1. Wirebond packages FG256, FG456, and FG676 are also available in Pb-free versions FGG256, FGG456, and FGG676. See Virtex-II Pro Ordering Examples for details on how to order.
2. Virtex-II Pro X device is equipped with RocketIO X transceiver cores.
3. The RocketIO transceivers in devices in the FF1148 and FF1696 packages are not bonded out to the package pins.

Maximum Performance

Maximum performance of the RocketIO / RocketIO X transceiver and the PowerPC processor block varies, depending on package style and speed grade. See Table 4 for details. Virtex-II Pro and Virtex-II Pro X Platform FPGAs: DC and Switching Characteristics contains the rest of the FPGA fabric performance parameters.

Table 4: **Maximum RocketIO / RocketIO X Transceiver and Processor Block Performance**

Device	Speed Grade			Units
	-7(1)	-6	-5	
RocketIO X Transceiver FlipChip (FF)	N/A	6.25(3)	4.25(3)	Gb/s
RocketIO Transceiver FlipChip (FF)	3.125	3.125	2.0	Gb/s
RocketIO Transceiver Wirebond (FG)	2.5	2.5	2.0	Gb/s
PowerPC Processor Block	400(2)	350(2)	300	MHz

Notes:
1. -7 speed grade devices are not available in Industrial grade.
2. **IMPORTANT!** When CPMC405CLOCK runs at speeds greater than 350 MHz in -7 Commercial grade dual-processor devices, or greater than 300 MHz in -6 Industrial grade dual-processor devices, users must implement the technology presented in **XAPP755**, "PowerPC 405 Clock Macro for -7(C) and -6(I) Speed Grade Dual-Processor Devices." Refer to Table 1 to identify dual-processor devices.
3. XC2VPX70 is only available at fixed 4.25 Gb/s baud rate.

RocketIO and RocketIO X Feature Comparison

Table 7 summarizes the major differences between the RocketIO and RocketIO X MGTs. The ***RocketIO X Transceiver User Guide*** has more details, including a design migration guide in the Appendix.

Table 7: **RocketIO PMA versus RocketIO X PMA**

	RocketIO X Transceiver	RocketIO Transceiver
PCS Features:		
FPGA interface	1, 2, 4, and 8 byte width	1, 2, and 4 byte width
Coding support	8B/10B and 64B/66B bypassable	8B/10B bypassable
Gearbox/scrambler support	Yes	N/A
CRC Support	No	Yes
Half rate	No	Yes
PMA Features:		
Baud rate	2.488 Gb/s - 6.25 Gb/s(2)	622 Mb/s - 3.125 Gb/s
Reference clock frequency tolerance	350 PPM	100 PPM
Reference clock multiplier	x16, x20, x32, x40	x20
Max run length	75	75
Receive equalization	Built-in analog linear, programmable	None
Output swing (differential p-p)	200 mV to 1600 mV, programmable	800 mV to 1600 mV, programmable
Pre-emphasis	0% to 500%, programmable	4 selectable levels from 10% to 33%
Slew rate control	2 selectable levels	None
Termination	On-chip internal, 50Ω	On-chip internal, 50Ω/75Ω selectable
AC coupling capacitor	On-chip internal. Can be AC- or DC-coupled externally	None
Transmit supply voltage (AVCCAUXTX)	2.5V	2.5V
Receive supply voltage (AVCCAUXRX)	1.5V, 1.8V(1)	2.5V
PMA configuration support	Direct, dynamic, and partial configuration	Partial configuration
Others:		
JTAG support	Input only	None
Process technology	0.13 µm	0.25 µm
Available packages	Flip-chip only	Flip-chip and wire-bond

Notes:
1. AVCCAUXRX for RocketIO X MGT is 1.5V (nominal) for 8B/10B-encoded data. For all other encoding protocols, AVCCAUXRX is 1.8V (nominal).
2. The XC2VPX70 operates at a fixed 4.25 Gb/s baud rate.

- The double lines route signals to every first or second block away in all four directions. Organized in a staggered pattern, double lines can be driven only at their endpoints. Double-line signals can be accessed either at the endpoints or at the midpoint (one block from the source).
- The direct connect lines route signals to neighboring blocks: vertically, horizontally, and diagonally.
- The fast connect lines are the internal CLB local interconnections from LUT outputs to LUT inputs.

Dedicated Routing

In addition to the global and local routing resources, dedicated signals are available.

- There are eight global clock nets per quadrant. (See Global Clock Multiplexer Buffers, page 48.)
- Horizontal routing resources are provided for on-chip 3-state buses. Four partitionable bus lines are provided per CLB row, permitting multiple buses within a row. (See 3-State Buffers, page 43.)
- Two dedicated carry-chain resources per slice column (two per CLB column) propagate carry-chain MUXCY output signals vertically to the adjacent slice. (See CLB/Slice Configurations, page 44.)
- One dedicated SOP chain per slice row (two per CLB row) propagate ORCY output logic signals horizontally to the adjacent slice. (See Sum of Products, page 42.)
- One dedicated shift-chain per CLB connects the output of LUTs in shift-register mode to the input of the next LUT in shift-register mode (vertically) inside the CLB. (See Shift Registers, page 39.)

Table 32: **RocketIO RXUSRCLK2 Switching Characteristics *(Continued)***

		Speed Grade			
Description	**Symbol**	**-7**	**-6**	**-5**	**Units**
RXBUFSTATUS status outputs	$T_{GCKST_}$RBSTA	0.45	0.45	0.50	ns, max
RXCHECKINGCRC status output	$T_{GCKST_}$RCCRC	0.36	0.40	0.44	ns, max
RXCRCERR status output	$T_{GCKST_}$RCRCE	0.36	0.40	0.44	ns, max
CHBONDDONE status output	$T_{GCKST_}$CHBD	0.50	0.50	0.55	ns, max
RXCHARISK status outputs	$T_{GCKST_}$RKCH	0.50	0.50	0.55	ns, max
RXRUNDISP status outputs	$T_{GCKST_}$RRDIS	0.50	0.50	0.55	ns, max
RXDATA data outputs	$T_{GCKDO_}$RDAT	0.50	0.50	0.55	ns, max
Clock					
RXUSRCLK2 minimum pulse width, High	$T_{GPWH_}$RX2	1.42	1.42	2.25	ns, min
RXUSRCLK2 minimum pulse width, Low	$T_{GPWL_}$RX2	1.42	1.42	2.25	ns, min

Table 33: **RocketIO X TXUSRCLK2 Switching Characteristics**

		Speed Grade			
Description	**Symbol**	**-7**	**-6**	**-5**	**Units**
Setup and Hold Relative to Clock (TXUSRCLK2)					
TXBYPASS8B10B control inputs	$T_{GCCK_}$TBYP/$T_{GCKC_}$TBYP				ns, min
TXPOLARITY control input	$T_{GCCK_}$TPOL/$T_{GCKC_}$TPOL				ns, min
TXINHIBIT control inputs	$T_{GCCK_}$TINH/$T_{GCKC_}$TINH				ns, min
LOOPBACK control inputs	$T_{GCCK_}$LBK/$T_{GCKC_}$LBK				ns, min
TXRESET control input	$T_{GCCK_}$TRST/$T_{GCKC_}$TRST				ns, min
TXCHARISK control inputs	$T_{GCCK_}$TKCH/$T_{GCKC_}$TKCH				ns, min
TXCHARDISPMODE control inputs	$T_{GCCK_}$TCDM/$T_{GCKC_}$TCDM				ns, min
TXCHARDISPVAL control inputs	$T_{GCCK_}$TCDV/$T_{GCKC_}$TCDV				ns, min
TXDATAWIDTH control inputs	$T_{GCCK_}$TDATW/$T_{GCCK_}$TDATW				ns, min
TXENC64B66BUSE TXENC8B10BUSE control inputs	$T_{GCCK_}$TENC/$T_{GCCK_}$TENC				ns, min
TXINTDATAWIDTH control inputs	$T_{GCCK_}$TIDATW/$T_{GCCK_}$TIDATW				ns, min
TXGEARBOX64B66BUSE control inputs	$T_{GCCK_}$TXGEAR/$T_{GCCK_}$TXGEAR				ns, min
TXSCRAM64B66BUSE control inputs	$T_{GCCK_}$TXSCBL/$T_{GCCK_}$TXSCBL				ns, min
REFCLKSEL REFCLKBSEL control inputs	$T_{GCCK_}$RFCKSL/$T_{GCCK_}$RFCKSL				ns, min
TXDATA data inputs	$T_{GDCK_}$TDAT/$T_{GCKD_}$TDAT				ns, min
Clock to Out					
TXBUFERR status output	$T_{GCKST_}$TBERR				ns, max
TXKERR status outputs	$T_{GCKST_}$TKERR				ns, max
TXRUNDISP status outputs	$T_{GCKST_}$TRDIS				ns, max
Clock					
TXUSRCLK2 minimum pulse width, High	$T_{GPWH_}$TX2				ns, min
TXUSRCLK2 minimum pulse width, Low	$T_{GPWL_}$TX2				ns, min

Output Delay Measurements

Output delays are measured using a Tektronix P6245 TDS500/600 probe (< 1 pF) across approximately 4" of FR4 microstrip trace. Standard termination was used for all testing. (See ***Virtex-II Pro Platform FPGA User Guide*** for details.) The propagation delay of the 4" trace is characterized separately and subtracted from the final measurement, and is therefore not included in the generalized test setup shown in Figure 6.

Measurements and test conditions are reflected in the IBIS models except where the IBIS format precludes it. (IBIS models can be found on the web at **http://support.xilinx.com/support/sw_ibis.htm**.) Parameters V_{REF}, R_{REF}, C_{REF}, and V_{MEAS} fully describe the test conditions for each I/O standard. The most accurate prediction of propagation delay in any given application can be obtained through IBIS simulation, using the following method:

1. Simulate the output driver of choice into the generalized test setup, using values from Table 40.
2. Record the time to V_{MEAS}.
3. Simulate the output driver of choice into the actual PCB trace and load, using the appropriate IBIS model or capacitance value to represent the load.
4. Record the time to V_{MEAS}.
5. Compare the results of steps 2 and 4. The increase or decrease in delay should be added to or subtracted from the I/O Output Standard Adjustment value (Table 38) to yield the actual worst-case propagation delay (clock-to-input) of the PCB trace.

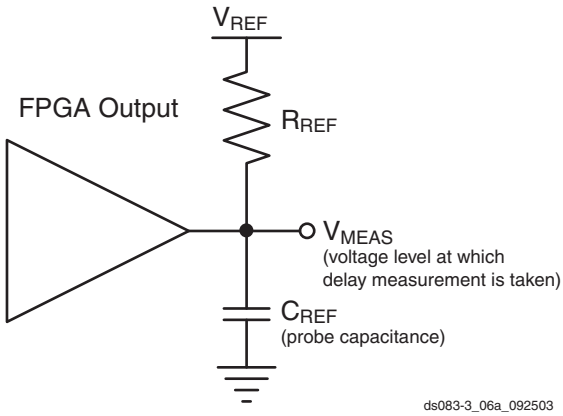

Figure 6: **Generalized Test Setup**

Table 40: **Output Delay Measurement Methodology**

Description	IOSTANDARD Attribute	R_{REF} (Ω)	C_{REF} (1) (pF)	V_{MEAS} (V)	V_{REF} (V)
LVTTL (Low-Voltage Transistor-Transistor Logic)	LVTTL (all)	1M	0	1.65	0
LVCMOS (Low-Voltage CMOS), 3.3V	LVCMOS33	1M	0	1.65	0
LVCMOS, 2.5V	LVCMOS25	1M	0	1.25	0
LVCMOS, 1.8V	LVCMOS18	1M	0	0.9	0
LVCMOS, 1.5V	LVCMOS15	1M	0	0.75	0
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3 (rising edge)	25	10 (2)	0.94	0
	PCI33_3 (falling edge)	25	10 (2)	2.03	3.3
PCI, 66 MHz, 3.3V	PCI66_3 (rising edge)	25	10 (2)	0.94	0
	PCI66_3 (falling edge)	25	10 (2)	2.03	3.3
PCI-X, 133 MHz, 3.3V	PCIX (rising edge)	25	10 (3)	0.94	0
	PCIX (falling edge	25	10 (3)	2.03	3.3
GTL (Gunning Transceiver Logic)	GTL	25	0	0.8	1.2
GTL Plus	GTLP	25	0	1.0	1.5
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	50	0	V_{REF}	0.75
HSTL, Class II	HSTL_II	25	0	V_{REF}	0.75
HSTL, Class III	HSTL_III	50	0	0.9	1.5
HSTL, Class IV	HSTL_IV	25	0	0.9	1.5
HSTL, Class I, 1.8V	HSTL_I_18	50	0	V_{REF}	0.9
HSTL, Class II, 1.8V	HSTL_II_18	25	0	V_{REF}	0.9
HSTL, Class III, 1.8V	HSTL_III_18	50	0	1.1	1.8
HSTL, Class IV, 1.8V	HSTL_IV_18	25	0	1.1	1.8

FG256/FGG256 Fine-Pitch BGA Package

As shown in Table 5, XC2VP2 and XC2VP4 Virtex-II Pro devices are available in the FG256/FGG256 fine-pitch BGA package. The pins in each of these devices are identical. Following this table are the FG256/FGG256 Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 5: **FG256/FGG256 — XC2VP2 and XC2VP4**

Bank	Pin Description	Pin Number
0	IO_L01N_0/VRP_0	C2
0	IO_L01P_0/VRN_0	C3
0	IO_L02N_0	B3
0	IO_L02P_0	C4
0	IO_L03N_0	A2
0	IO_L03P_0/VREF_0	A3
0	IO_L06N_0	D5
0	IO_L06P_0	C5
0	IO_L07P_0	D6
0	IO_L09N_0	E6
0	IO_L09P_0/VREF_0	E7
0	IO_L69N_0	D7
0	IO_L69P_0/VREF_0	C7
0	IO_L74N_0/GCLK7P	D8
0	IO_L74P_0/GCLK6S	C8
0	IO_L75N_0/GCLK5P	B8
0	IO_L75P_0/GCLK4S	A8
1	IO_L75N_1/GCLK3P	A9
1	IO_L75P_1/GCLK2S	B9
1	IO_L74N_1/GCLK1P	C9
1	IO_L74P_1/GCLK0S	D9
1	IO_L69N_1/VREF_1	C10
1	IO_L69P_1	D10
1	IO_L09N_1/VREF_1	E10
1	IO_L09P_1	E11
1	IO_L07N_1	D11
1	IO_L06N_1	C12
1	IO_L06P_1	D12
1	IO_L03N_1/VREF_1	A14
1	IO_L03P_1	A15

Table 5: **FG256/FGG256 — XC2VP2 and XC2VP4**

Bank	Pin Description	Pin Number
N/A	AVCCAUXRX7	B13
N/A	AVCCAUXRX18	R13
N/A	VTRXPAD18	R12
N/A	RXNPAD18	T13
N/A	RXPPAD18	T12
N/A	GNDA18	P11
N/A	TXPPAD18	T11
N/A	TXNPAD18	T10
N/A	VTTXPAD18	R10
N/A	AVCCAUXTX18	R11
N/A	AVCCAUXRX19	R7
N/A	VTRXPAD19	R6
N/A	RXNPAD19	T7
N/A	RXPPAD19	T6
N/A	GNDA19	P6
N/A	TXPPAD19	T5
N/A	TXNPAD19	T4
N/A	VTTXPAD19	R4
N/A	AVCCAUXTX19	R5
N/A	VCCINT	N4
N/A	VCCINT	N13
N/A	VCCINT	M5
N/A	VCCINT	M12
N/A	VCCINT	E5
N/A	VCCINT	E12
N/A	VCCINT	D4
N/A	VCCINT	D13
N/A	VCCAUX	R16
N/A	VCCAUX	R1
N/A	VCCAUX	B16
N/A	VCCAUX	B1
N/A	GND	T16
N/A	GND	T1
N/A	GND	R2

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	VCCO_7	K7			
7	VCCO_7	J7			
7	VCCO_7	H6			
7	VCCO_7	G6			
N/A	CCLK	W20			
N/A	PROG_B	B1			
N/A	DONE	Y18			
N/A	M0	Y4			
N/A	M1	W3			
N/A	M2	Y5			
N/A	TCK	B22			
N/A	TDI	D3			
N/A	TDO	D20			
N/A	TMS	A21			
N/A	PWRDWN_B	Y19			
N/A	HSWAP_EN	A2			
N/A	RSVD	C18			
N/A	VBATT	C19			
N/A	DXP	C4			
N/A	DXN	C5			
N/A	AVCCAUXTX4	B4	NC	NC	
N/A	VTTXPAD4	B3	NC	NC	
N/A	TXNPAD4	A3	NC	NC	
N/A	TXPPAD4	A4	NC	NC	
N/A	GNDA4	C6	NC	NC	
N/A	RXPPAD4	A5	NC	NC	
N/A	RXNPAD4	A6	NC	NC	
N/A	VTRXPAD4	B5	NC	NC	
N/A	AVCCAUXRX4	B6	NC	NC	
N/A	AVCCAUXTX6	B8			
N/A	VTTXPAD6	B7			
N/A	TXNPAD6	A7			
N/A	TXPPAD6	A8			
N/A	GNDA6	C9			
N/A	RXPPAD6	A9			
N/A	RXNPAD6	A10			

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
N/A	AVCCAUXTX18	AA14			
N/A	AVCCAUXRX19	AA10			
N/A	VTRXPAD19	AA9			
N/A	RXNPAD19	AB10			
N/A	RXPPAD19	AB9			
N/A	GNDA19	Y9			
N/A	TXPPAD19	AB8			
N/A	TXNPAD19	AB7			
N/A	VTTXPAD19	AA7			
N/A	AVCCAUXTX19	AA8			
N/A	AVCCAUXRX21	AA6	NC	NC	
N/A	VTRXPAD21	AA5	NC	NC	
N/A	RXNPAD21	AB6	NC	NC	
N/A	RXPPAD21	AB5	NC	NC	
N/A	GNDA21	Y6	NC	NC	
N/A	TXPPAD21	AB4	NC	NC	
N/A	TXNPAD21	AB3	NC	NC	
N/A	VTTXPAD21	AA3	NC	NC	
N/A	AVCCAUXTX21	AA4	NC	NC	
N/A	VCCINT	U6			
N/A	VCCINT	U17			
N/A	VCCINT	T8			
N/A	VCCINT	T7			
N/A	VCCINT	T16			
N/A	VCCINT	T15			
N/A	VCCINT	R7			
N/A	VCCINT	R16			
N/A	VCCINT	H7			
N/A	VCCINT	H16			
N/A	VCCINT	G8			
N/A	VCCINT	G7			
N/A	VCCINT	G16			
N/A	VCCINT	G15			
N/A	VCCINT	F6			
N/A	VCCINT	F17			
N/A	VCCAUX	M22			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
4	IO_L05_4/No_Pair	Y8			
4	IO_L06N_4/VRP_4	AB8			
4	IO_L06P_4/VRN_4	AB9			
4	IO_L07N_4	AC8			
4	IO_L07P_4/VREF_4	AD8			
4	IO_L08N_4	AE8			
4	IO_L08P_4	AF8			
4	IO_L09N_4	Y9			
4	IO_L09P_4/VREF_4	AA9			
4	IO_L37N_4	AC9	NC	NC	
4	IO_L37P_4	AD9	NC	NC	
4	IO_L38N_4	Y10	NC	NC	
4	IO_L38P_4	W11	NC	NC	
4	IO_L39N_4	AA10	NC	NC	
4	IO_L39P_4	AA11	NC	NC	
4	IO_L43N_4	AB10	NC	NC	
4	IO_L43P_4	AC10	NC	NC	
4	IO_L44N_4	Y11	NC	NC	
4	IO_L44P_4	Y12	NC	NC	
4	IO_L45N_4	AB11	NC	NC	
4	IO_L45P_4/VREF_4	AC11	NC	NC	
4	IO_L67N_4	AA12			
4	IO_L67P_4	AB12			
4	IO_L68N_4	AC12			
4	IO_L68P_4	AD12			
4	IO_L69N_4	W12			
4	IO_L69P_4/VREF_4	W13			
4	IO_L73N_4	Y13			
4	IO_L73P_4	AA13			
4	IO_L74N_4/GCLK3S	AB13			
4	IO_L74P_4/GCLK2P	AC13			
4	IO_L75N_4/GCLK1S	AD13			
4	IO_L75P_4/GCLK0P	AE13			
5	IO_L75N_5/GCLK7S	AE14			
5	IO_L75P_5/GCLK6P	AD14			
5	IO_L74N_5/GCLK5S	AC14			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
3	IO_L39P_3	AD4				
3	IO_L38N_3	AB9				
3	IO_L38P_3	AB10				
3	IO_L37N_3	AD5				
3	IO_L37P_3	AD6				
3	IO_L36N_3	AE2				
3	IO_L36P_3	AF2				
3	IO_L35N_3	AD7				
3	IO_L35P_3	AD8				
3	IO_L34N_3	AE4				
3	IO_L34P_3	AE5				
3	IO_L33N_3/VREF_3	AG1				
3	IO_L33P_3	AG2				
3	IO_L32N_3	AC9				
3	IO_L32P_3	AC10				
3	IO_L31N_3	AF3				
3	IO_L31P_3	AF4				
3	IO_L24N_3	AH1	NC			
3	IO_L24P_3	AH2	NC			
3	IO_L23N_3	AE7	NC			
3	IO_L23P_3	AE8	NC			
3	IO_L22N_3	AF5	NC			
3	IO_L22P_3	AF6	NC			
3	IO_L21N_3/VREF_3	AG3	NC			
3	IO_L21P_3	AG4	NC			
3	IO_L20N_3	AD9	NC			
3	IO_L20P_3	AD10	NC			
3	IO_L19N_3	AH3	NC			
3	IO_L19P_3	AH4	NC			
3	IO_L18N_3	AJ1	NC			
3	IO_L18P_3	AJ2	NC			
3	IO_L17N_3	AF7	NC			
3	IO_L17P_3	AF8	NC			
3	IO_L16N_3	AK1	NC			
3	IO_L16P_3	AK2	NC			
3	IO_L15N_3/VREF_3	AG5	NC			
3	IO_L15P_3	AG6	NC			
3	IO_L06N_3	AL1				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L86N_7	U25				
7	IO_L85P_7	T32				
7	IO_L85N_7	T31				
7	IO_L60P_7	T30				
7	IO_L60N_7	T29				
7	IO_L59P_7	T28				
7	IO_L59N_7	T27				
7	IO_L58P_7	T33				
7	IO_L58N_7/VREF_7	R33				
7	IO_L57P_7	R32				
7	IO_L57N_7	R31				
7	IO_L56P_7	T26				
7	IO_L56N_7	T25				
7	IO_L55P_7	R34				
7	IO_L55N_7	P34				
7	IO_L54P_7	R29				
7	IO_L54N_7	R28				
7	IO_L53P_7	U24				
7	IO_L53N_7	T24				
7	IO_L52P_7	P32				
7	IO_L52N_7/VREF_7	P31				
7	IO_L51P_7	P30				
7	IO_L51N_7	P29				
7	IO_L50P_7	R26				
7	IO_L50N_7	R25				
7	IO_L49P_7	P33				
7	IO_L49N_7	N33				
7	IO_L48P_7	N32				
7	IO_L48N_7	N31				
7	IO_L47P_7	P28				
7	IO_L47N_7	P27				
7	IO_L46P_7	N34				
7	IO_L46N_7/VREF_7	M34				
7	IO_L45P_7	N30				
7	IO_L45N_7	N29				
7	IO_L44P_7	P26				
7	IO_L44N_7	P25				
7	IO_L43P_7	M32				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
N/A	VTTXPAD21	AN29				
N/A	AVCCAUXTX21	AN28				
N/A	AVCCAUXRX23	AN30	NC	NC		
N/A	VTRXPAD23	AN31	NC	NC		
N/A	RXNPAD23	AP30	NC	NC		
N/A	RXPPAD23	AP31	NC	NC		
N/A	GNDA23	AM30	NC	NC		
N/A	TXPPAD23	AP32	NC	NC		
N/A	TXNPAD23	AP33	NC	NC		
N/A	VTTXPAD23	AN33	NC	NC		
N/A	AVCCAUXTX23	AN32	NC	NC		
N/A	VCCINT	L11				
N/A	VCCINT	L24				
N/A	VCCINT	M12				
N/A	VCCINT	M23				
N/A	VCCINT	N13				
N/A	VCCINT	N14				
N/A	VCCINT	N15				
N/A	VCCINT	N16				
N/A	VCCINT	N17				
N/A	VCCINT	N18				
N/A	VCCINT	N19				
N/A	VCCINT	N20				
N/A	VCCINT	N21				
N/A	VCCINT	N22				
N/A	VCCINT	P13				
N/A	VCCINT	P22				
N/A	VCCINT	R13				
N/A	VCCINT	R22				
N/A	VCCINT	T13				
N/A	VCCINT	T22				
N/A	VCCINT	U13				
N/A	VCCINT	U22				
N/A	VCCINT	V13				
N/A	VCCINT	V22				
N/A	VCCINT	W13				
N/A	VCCINT	W22				

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
4	IO_L03N_4/D2	AN10		
4	IO_L03P_4/D3	AM10		
4	IO_L05_4/No_Pair	AK10		
4	IO_L06N_4/VRP_4	AR10		
4	IO_L06P_4/VRN_4	AP10		
4	IO_L07N_4	AU10		
4	IO_L07P_4/VREF_4	AT10		
4	IO_L08N_4	AJ12		
4	IO_L08P_4	AJ13		
4	IO_L09N_4	AL10		
4	IO_L09P_4/VREF_4	AL11		
4	IO_L19N_4	AN11		
4	IO_L19P_4	AM11		
4	IO_L20N_4	AH13		
4	IO_L20P_4	AH14		
4	IO_L21N_4	AR11		
4	IO_L21P_4	AP11		
4	IO_L25N_4	AU11		
4	IO_L25P_4	AT11		
4	IO_L26N_4	AL14		
4	IO_L26P_4	AK14		
4	IO_L27N_4	AM12		
4	IO_L27P_4/VREF_4	AL12		
4	IO_L28N_4	AT12	NC	
4	IO_L28P_4	AR12	NC	
4	IO_L29N_4	AJ14	NC	
4	IO_L29P_4	AJ15	NC	
4	IO_L30N_4	AM13	NC	
4	IO_L30P_4	AL13	NC	
4	IO_L34N_4	AP12	NC	
4	IO_L34P_4	AN13	NC	
4	IO_L35N_4	AL15	NC	
4	IO_L35P_4	AK15	NC	
4	IO_L36N_4	AT13	NC	
4	IO_L36P_4/VREF_4	AR13	NC	
4	IO_L37N_4	AN14		
4	IO_L37P_4	AM14		
4	IO_L38N_4	AH15		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	VCCAUX	AP6		
N/A	VCCAUX	F6		
N/A	VCCAUX	AR5		
N/A	VCCAUX	E5		
N/A	VCCAUX	AW2		
N/A	VCCAUX	Y2		
N/A	VCCAUX	A2		
N/A	VCCAUX	AV1		
N/A	VCCAUX	AA1		
N/A	VCCAUX	Y1		
N/A	VCCAUX	W1		
N/A	VCCAUX	B1		
N/A	GND	A3		
N/A	GND	AV2		
N/A	GND	AU2		
N/A	GND	AA2		
N/A	GND	W2		
N/A	GND	C2		
N/A	GND	B2		
N/A	GND	AU1		
N/A	GND	AM1		
N/A	GND	AH1		
N/A	GND	AD1		
N/A	GND	T1		
N/A	GND	M1		
N/A	GND	H1		
N/A	GND	C1		
N/A	GND	AD5		
N/A	GND	T5		
N/A	GND	M5		
N/A	GND	H5		
N/A	GND	AU4		
N/A	GND	AT4		
N/A	GND	D4		
N/A	GND	C4		
N/A	GND	AW3		
N/A	GND	AV3		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	VCCINT		U26		
N/A	VCCINT		U17		
N/A	VCCINT		U16		
N/A	VCCINT		T27		
N/A	VCCINT		T26		
N/A	VCCINT		T25		
N/A	VCCINT		T24		
N/A	VCCINT		T23		
N/A	VCCINT		T22		
N/A	VCCINT		T21		
N/A	VCCINT		T20		
N/A	VCCINT		T19		
N/A	VCCINT		T18		
N/A	VCCINT		T17		
N/A	VCCINT		T16		
N/A	VCCINT		R28		
N/A	VCCINT		R27		
N/A	VCCINT		R26		
N/A	VCCINT		R17		
N/A	VCCINT		R16		
N/A	VCCINT		R15		
N/A	VCCINT		P29		
N/A	VCCINT		P28		
N/A	VCCINT		P27		
N/A	VCCINT		P16		
N/A	VCCINT		P15		
N/A	VCCINT		P14		
N/A	VCCINT		N30		
N/A	VCCINT		N13		
N/A	VCCAUX		AB42		
N/A	VCCAUX		AB41		
N/A	VCCAUX		AB2		
N/A	VCCAUX		AB1		
N/A	VCCAUX		AC42		
N/A	VCCAUX		AC1		
N/A	VCCAUX		AM32		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AU25		
N/A	GND		AU18		
N/A	GND		AU6		
N/A	GND		AV38		
N/A	GND		AV22		
N/A	GND		AV21		
N/A	GND		AV5		
N/A	GND		AW39		
N/A	GND		AW32		
N/A	GND		AW28		
N/A	GND		AW15		
N/A	GND		AW11		
N/A	GND		AW4		
N/A	GND		AY42		
N/A	GND		AY41		
N/A	GND		AY40		
N/A	GND		AY3		
N/A	GND		AY2		
N/A	GND		AY1		
N/A	GND		BA42		
N/A	GND		BA1		
N/A	GND		AA38		
N/A	GND		AA35		
N/A	GND		AA32		
N/A	GND		AA26		
N/A	GND		AA25		
N/A	GND		AA24		
N/A	GND		AA23		
N/A	GND		AA22		
N/A	GND		AA21		
N/A	GND		AA20		
N/A	GND		AA19		
N/A	GND		AA18		
N/A	GND		AA17		
N/A	GND		AA11		
N/A	GND		AA8		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L87N_1/VREF_1	C15	
1	IO_L87P_1	C16	
1	IO_L86N_1	K15	
1	IO_L86P_1	J15	
1	IO_L85N_1	F15	
1	IO_L85P_1	E15	
1	IO_L84N_1	G15	
1	IO_L84P_1	G16	
1	IO_L83_1/No_Pair	M15	
1	IO_L80_1/No_Pair	L15	
1	IO_L79N_1	B14	
1	IO_L79P_1	A14	
1	IO_L78N_1	C14	
1	IO_L78P_1	D15	
1	IO_L77N_1	K14	
1	IO_L77P_1	J14	
1	IO_L76N_1	F14	
1	IO_L76P_1	E14	
1	IO_L36N_1/VREF_1	G14	
1	IO_L36P_1	H15	
1	IO_L35N_1	M14	
1	IO_L35P_1	L14	
1	IO_L34N_1	C13	
1	IO_L34P_1	B13	
1	IO_L30N_1	G13	
1	IO_L30P_1	F13	
1	IO_L29N_1	L13	
1	IO_L29P_1	K13	
1	IO_L28N_1	C12	
1	IO_L28P_1	B12	
1	IO_L27N_1/VREF_1	D12	
1	IO_L27P_1	D13	
1	IO_L26N_1	J12	
1	IO_L26P_1	H12	
1	IO_L25N_1	F12	
1	IO_L25P_1	E12	
1	IO_L21N_1	G12	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
4	IO_L39N_4	AM16	
4	IO_L39P_4	AL16	
4	IO_L43N_4	AR17	
4	IO_L43P_4	AR16	
4	IO_L44N_4	AV16	
4	IO_L44P_4	AU16	
4	IO_L45N_4	AP16	
4	IO_L45P_4/VREF_4	AN16	
4	IO_L10N_4	AW17	NC
4	IO_L10P_4	AW16	NC
4	IO_L11N_4	BB16	NC
4	IO_L11P_4	BA16	NC
4	IO_L12N_4	AL18	NC
4	IO_L12P_4	AL17	NC
4	IO_L16N_4	AU17	NC
4	IO_L16P_4	AT17	NC
4	IO_L18N_4	BA17	NC
4	IO_L18P_4/VREF_4	AY17	NC
4	IO_L46N_4	AT19	
4	IO_L46P_4	AT18	
4	IO_L47N_4	AN17	
4	IO_L47P_4	AM17	
4	IO_L48N_4	AV18	
4	IO_L48P_4	AU18	
4	IO_L49N_4	AY19	
4	IO_L49P_4	AY18	
4	IO_L50_4/No_Pair	AM19	
4	IO_L53_4/No_Pair	AM18	
4	IO_L54N_4	BB18	
4	IO_L54P_4	BA18	
4	IO_L55N_4	AR20	
4	IO_L55P_4	AR19	
4	IO_L56N_4	AP18	
4	IO_L56P_4	AN18	
4	IO_L57N_4	AV19	
4	IO_L57P_4/VREF_4	AU19	
4	IO_L58N_4	AW20	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L52P_6	AF40	
6	IO_L52N_6	AF41	
6	IO_L53P_6	AC36	
6	IO_L53N_6	AC37	
6	IO_L54P_6	AE41	
6	IO_L54N_6	AE42	
6	IO_L55P_6	AE40	
6	IO_L55N_6	AD40	
6	IO_L56P_6	AC31	
6	IO_L56N_6	AC32	
6	IO_L57P_6	AE38	
6	IO_L57N_6/VREF_6	AE39	
6	IO_L58P_6	AD41	
6	IO_L58N_6	AD42	
6	IO_L59P_6	AB35	
6	IO_L59N_6	AB36	
6	IO_L60P_6	AD37	
6	IO_L60N_6	AD38	
6	IO_L85P_6	AC40	
6	IO_L85N_6	AC41	
6	IO_L86P_6	AB33	
6	IO_L86N_6	AB34	
6	IO_L87P_6	AC39	
6	IO_L87N_6/VREF_6	AB39	
6	IO_L88P_6	AB40	
6	IO_L88N_6	AB41	
6	IO_L89P_6	AB31	
6	IO_L89N_6	AB32	
6	IO_L90P_6	AB37	
6	IO_L90N_6	AB38	
7	IO_L90P_7	AA40	
7	IO_L90N_7	AA41	
7	IO_L89P_7	AA35	
7	IO_L89N_7	AA36	
7	IO_L88P_7	Y39	
7	IO_L88N_7/VREF_7	AA39	